

ADVANCED DIRECT IMAGING by ALTIX

ADIX SA







Higher Precision Reliability Flexibility

IX Т

Unique Solution for All Direct Imaging Applications



Direct Imaging & Contact Printers



ADIX SA for All Imaging Needs



High Power LEDs High Resolution DMD



Enhanced 4 LEDs Photo Heads for Higher **Productivity and Printing Quality**

High Accuracy Registration

Print on All Types of Photoresists & Soldermasks

Lower Cost of Ownership

Fully Intuitive & Friendly HMI

From 1 to 6 ALDS-Power4+[™] Photo Heads - Upgradable on site

ADIX SA Specifications Higher Resolution: 10µm L/S(*) Use multi-wavelengths UV-LED for best resolution and higher polymerization efficiency on all APPLICATIONS PCB • FPCB / Flex • Photo Chemical Milling • IC Substrate • Touch Panel types of conventional dry film, ink Inner Layer • Outer Layer • Soldermask (PSR) Conventional Process or solder resists Imaging Resist Materials & DI/LDI Specific Dry Film, Ink & Solder Resists From 10 to **Resist Sensitivity** 1.250mJ/cm² and above (*) Depend on Photo Head Type Exposure Area From 228 x 254mm up to 610 x 762mm • From 9"x10" up to 24"x30" Panel Thickness Highest Imaging Quality with ALDS™ • 10/10µm • 0.4/0.4 mil⁽¹⁾ 0.04 to 6mm 1,6 to 236mils 20/20µm • 0.8/0.8 mil(1) **RESOLUTION – L/S** Imaging on double or triple dry NA 25µm (1mil) **RESOLUTION – DAM** film laminated layers ±0,5µm Edge Roughness ±1,5µm Depth of Focus 100um 200um ALDS-Power4+™ Excellent and sharp edges Light Engine From 1 to 6 Heads - Upgradable on site Imaging Heads Autofocus ±8mm • ±315mils 4 LEDs wavelengths per Photo Head **Exposure Spectrum** Higher Registration: ±8µm ±0.3mil (Image to Panel Registration) ±0.5mil (Side to Side Registration) ±8µm • ALIGNMENT Real time scaling and partitioning ±12um to reach the highest local registration for very demanding - for Outer Layers (Alignment on 4 Holes) 2 Cameras - for Soldermask Registration (Alignment on 4 Copper Targets) 3 Cameras for Inner Layers (Alignment on 3 Fiducials) **CCD** Cameras application Method Real Time Scaling & Partitioning with all kinds of fiducials THROUGHPUT Exposure Time 14s with 30mJ/cm² resist for 457 x 610mm (18"x 24") image size and with 6 Heads (2) ALDS-Power4™ Data preprocessing in hidden time + High UV Power with 4 LEDs per Photo Head Side to Side Registration:±12µm ALTIX Direct Imaging Suite™ with 22" touch screen SOFTWARE Highest side-to-side registration Data Input Extended Gerber, ODB++ (option) - Others upon request Languages on all area of the panels thanks English, Simplified & Traditional Chinese, Korean, German, French. HIGH YIELD to its unique way of registration Air Cleanliness Hepa Filter Class 100 Features Stainless Steel (Frames & Covers) GENERAL UTILITIES Power Supply 220/400/480V 3 Phases 50/60Hz **Power Consumption** 4kW Higher Productivity Air Supply 6 bars |1.5m3/min 4 UV LED wavelengths for the Water Supply Water pressure 3~5 bars Flow rate: 23l/min @ 12°C or 33l/min @ 14°C highest efficiency printing Machine Weight 3,500kg • 7,716lbs Dimensions 2,870mm (L) x 1,750mm (W) x 1,870mm (H) • 113" (L) x 69" (W) x 74" (H) (1) depending on pho **Unique Features Smart Automation** Fully automated systems and **Unique Panel Holding Highest Image Quality** customized solutions for high Fully automated bar clamping system ±8mm high dynamic autofocus & vacuum table for holding all panels and up to ±200µm depth of mix, small, medium & mass thicknesses and counteract warp & focus to overcome uneven production twist



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topography surfaces

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